

APPLICABLE STANDARD					
RATING	OPERATING TEMPERATURE RANGE	-30°C TO + 85°C (NOTE 1)	STORAGE TEMPERATURE RANGE	-10°C TO + 60°C (NOTE 3)	
	OPERATING HUMIDITY RANGE	40% TO + 80% (NOTE 2)	STORAGE HUMIDITY RANGE	40% TO + 70% (NOTE 3)	
	VOLTAGE	250V AC	CURRENT	2A	
SPECIFICATIONS					
ITEM		TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION					
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING		CONFIRMED VISUALLY.		X	X
ELECTRIC CHARACTERISTICS					
CONTACT RESISTANCE		100mA (DC OR 1000 Hz).	30mΩ MAX.	X	—
INSULATION RESISTANCE		500V DC.	1000MΩ MIN.	X	—
VOLTAGE PROOF		650V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	—
MECHANICAL CHARACTERISTICS					
MECHANICAL OPERATION		30TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 30mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
ENVIRONMENTAL CHARACTERISTICS					
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55→ 5 TO 35→+85→ 5 TO 35 °C TIME 30→ 2 TO 3 → 30→ 2 TO 3 min UNDER 5 CYCLES.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 1000MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
RESISTANCE TO SOLDERING HEAT		①AUTOMATIC SOLDERING (FLOW) SOLDER TEMPERATURE : 260°C FOR IMMERSION,DURATION : 5 sec . ②MANUAL SOLDERING SOLDERING IRON TEMPERATURE : 300°C SOLDERING TIME : 2 sec. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	—
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE, 230°C FOR INSERTION DURATION, 3sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	X	—
REMARKS					
NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT					
NOTE 2:NO CONDENSING.					
NOTE 3:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD, AFTER PCB BOARD, OPERATINGTEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION.					
	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
Unless otherwise specifid , refer to JIS C 5402.			APPROVED	TY. OMA	07. 05. 31
			CHECKED	HK. UMEHARA	07. 05. 30
			DESIGNED	TT. OHSAKO	07. 05. 24
			DRAWN	TT. OHSAKO	07. 05. 24
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWING NO.		ELC4-020824-01
	SPECIFICATION SHEET		PART NO.	DF11-22DP-2DSA (08)	
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL543-0526-6-08	 1/